

HIGH-SPEED DIFFERENTIAL LINE RECEIVERS

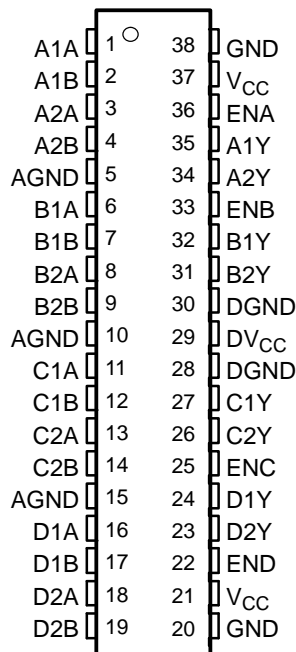
- Four- ('390), Eight- ('388A), or Sixteen- ('386) Line Receivers Meet or Exceed the Requirements of ANSI TIA/EIA-644 Standard
- Integrated 110-Ω Line Termination Resistors on LVDT Products
- Designed for Signaling Rates ⁽¹⁾ Up To 630 Mbps
- SN65 Version's Bus-Terminal ESD Exceeds 15 kV
- Operates From a Single 3.3-V Supply
- Typical Propagation Delay Time of 2.6 ns
- Output Skew 100 ps (Typ) Part-To-Part Skew Is Less Than 1 ns
- LVTTTL Levels Are 5-V Tolerant
- Open-Circuit Fail Safe
- Flow-Through Pinout
- Packaged in Thin Shrink Small-Outline Package With 20-mil Terminal Pitch

DESCRIPTION

This family of four-, eight-, or sixteen-, differential line receivers (with optional integrated termination) implements the electrical characteristics of low-voltage differential signaling (LVDS). This signaling technique lowers the output voltage levels of 5-V differential standard levels (such as EIA/TIA-422B) to reduce the power, increase the switching speeds, and allow operation with a 3-V supply rail. Any of the eight or sixteen differential receivers provides a valid logical output state with a ± 100 -mV differential input voltage within the input common-mode voltage range. The input common-mode voltage range allows 1 V of ground potential difference between two LVDS nodes. Additionally, the high-speed switching of LVDS signals almost always requires the use of a line impedance matching resistor at the receiving end of the cable or transmission media. The LVDT products eliminate this external resistor by integrating it with the receiver.

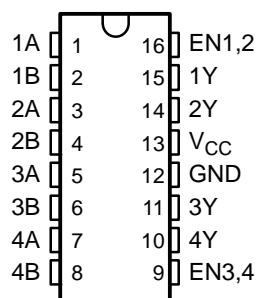
(1) Signaling Rate, $1/t$, where t is the minimum unit interval and is expressed in the units bits/s (bits per second)

'LVDS388A, 'LVDT388A
DBT PACKAGE
(TOP VIEW)

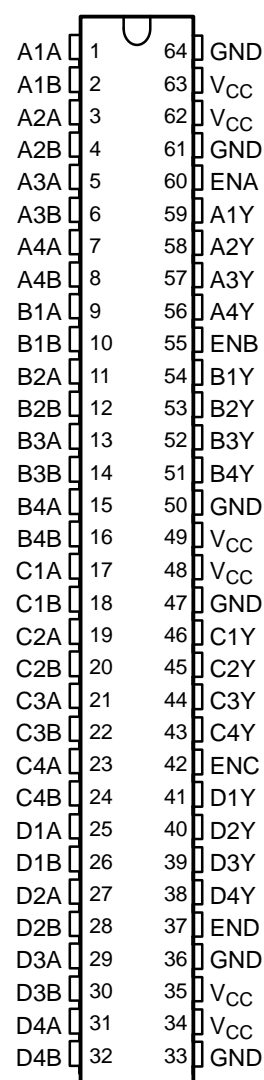


See application section for V_{CC} and GND description.

'LVDS390, 'LVDT390
D OR PW PACKAGE
(TOP VIEW)



'LVDS386, 'LVDT386
DGG PACKAGE
(TOP VIEW)



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These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

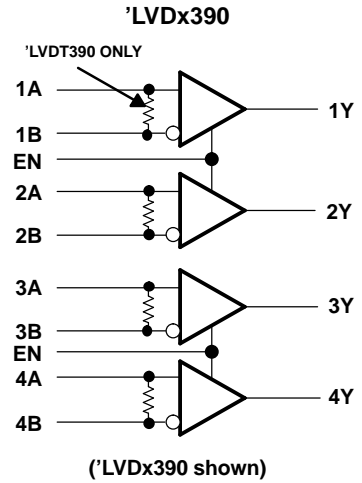
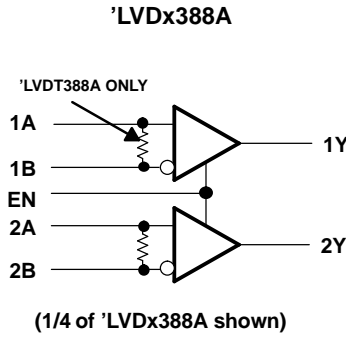
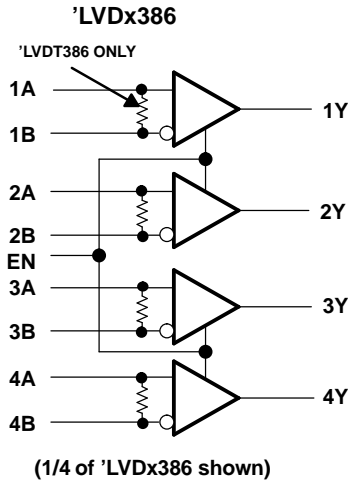
DESCRIPTION (CONTINUED)

The intended application of this device and signaling technique is for point-to-point baseband data transmission over controlled impedance media of approximately 100 Ω. The transmission media may be printed-circuit board traces, backplanes, or cables. The large number of receivers integrated into the same substrate along with the low pulse skew of balanced signaling, allows extremely precise timing alignment of clock and data for synchronous parallel data transfers. When used with its companion, 8- or 16-channel driver, the SN65LVDS389 or SN65LVDS387, over 300 million data transfers per second in single-edge clocked systems are possible with little power. (Note: The ultimate rate and distance of data transfer depends on the attenuation characteristics of the media, the noise coupling to the environment, and other system characteristics.)

AVAILABLE OPTIONS

| PART NUMBER | TEMPERATURE RANGE | NUMBER OF RECEIVERS | BUS-PIN ESD | SYMBOLIZATION |
|-----------------|-------------------|---------------------|-------------|---------------|
| SN65LVDS386DGG | –40°C to 85°C | 16 | 15 kV | LVDS386 |
| SN65LVDT386DGG | –40°C to 85°C | 16 | 15 kV | LVDT386 |
| SN75LVDS386DGG | 0°C to 70°C | 16 | 4 kV | 75LVDS386 |
| SN75LVDT386DGG | 0°C to 70°C | 16 | 4 kV | 75LVDT386 |
| SN65LVDS388ADBT | –40°C to 85°C | 8 | 15 kV | LVDS388A |
| SN65LVDT388ADBT | –40°C to 85°C | 8 | 15 kV | LVDT388A |
| SN75LVDS388ADBT | 0°C to 70°C | 8 | 4 kV | 75LVDS388A |
| SN75LVDT388ADBT | 0°C to 70°C | 8 | 4 kV | 75LVDT388A |
| SN65LVDS390D | –40°C to 85°C | 4 | 15 kV | LVDS390 |
| SN65LVDS390PW | –40°C to 85°C | 4 | 15 kV | LVDS390 |
| SN65LVDT390D | –40°C to 85°C | 4 | 15 kV | LVDT390 |
| SN65LVDT390PW | –40°C to 85°C | 4 | 15 kV | LVDT390 |
| SN75LVDS390D | 0°C to 70°C | 4 | 4 kV | 75LVDS390 |
| SN75LVDS390PW | 0°C to 70°C | 4 | 4 kV | DS390 |
| SN75LVDT390D | 0°C to 70°C | 4 | 4 kV | 75LVDT390 |
| SN75LVDT390PW | 0°C to 70°C | 4 | 4 kV | DG390 |

LOGIC DIAGRAM (POSITIVE LOGIC)

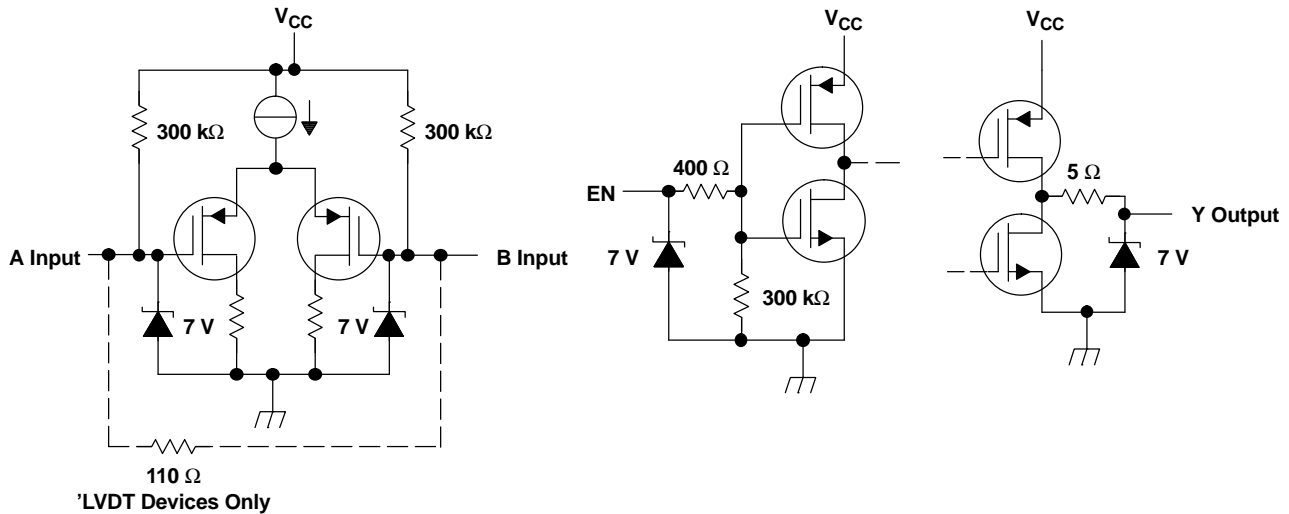


FUNCTION TABLE

| SNx5LVD386/388A/390 and SNx5LVDT386/388A/390 | | |
|--|------------------------|-----------------------|
| DIFFERENTIAL INPUT ⁽¹⁾ | ENABLES ⁽¹⁾ | OUTPUT ⁽¹⁾ |
| A-B | EN | Y |
| $V_{ID} \geq 100 \text{ mV}$ | H | H |
| $-100 \text{ mV} < V_{ID} \leq 100 \text{ mV}$ | H | ? |
| $V_{ID} \leq -100 \text{ mV}$ | H | L |
| X | L | Z |
| Open | H | H |

(1) H = high level, L = low level, X = irrelevant, Z = high impedance (off), ? = indeterminate

EQUIVALENT INPUT AND OUTPUT SCHEMATIC DIAGRAMS



ABSOLUTE MAXIMUM RATINGS

over operating free-air temperature (unless otherwise noted) ⁽¹⁾

| | | | UNITS |
|--------------------------------|--|-----------------------------|------------------------------|
| V _{CC} ⁽²⁾ | Supply voltage range | | −0.5 V to 4 V |
| V _I | Voltage range: | Enables or Y | −0.5 V to 6 V |
| | | A or B | −0.5 V to 4 V |
| I _O | Output current | Y | ±12 mA |
| V _{ID} | Differential input voltage magnitude | SN65LVDT' or SN75LVDT' only | 1 V |
| | Electrostatic discharge: see ⁽³⁾ | SN65' (A, B, and GND) | Class 3, A:15 kV, B: 700 V |
| | | SN75' (A, B, and GND) | Class 2, A:4 kV, B: 400 V |
| Continuous power dissipation | | | See Dissipation Rating Table |
| T _{stg} | Storage temperature range | | −65°C to 150°C |
| | Lead temperature 1,6 mm (1/16 in) from case for 10 seconds | | 260°C |

- (1) Stresses beyond those listed under absolute maximum ratings may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under recommended operating conditions is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) All voltage values, except differential I/O bus voltages, are with respect to network ground terminal.
- (3) Tested in accordance with MIL-STD-883C Method 3015.7.

DISSIPATION RATING TABLE

| PACKAGE | T _A ≤ 25°C | DERATING FACTOR ⁽¹⁾ ABOVE T _A = 25°C | T _A = 70°C POWER RATING | T _A = 85°C POWER RATING |
|---------|-----------------------|---|---------------------------------------|---------------------------------------|
| D | 950 mW | 7.6 mW/°C | 608 mW | 494 mW |
| DBT | 1071 mW | 8.5 mW/°C | 688 mW | 556 mW |
| DGG | 2094 mW | 16.7 mW/°C | 1342 mW | 1089 mW |
| PW | 774 mW | 6.2 mW/°C | 496 mW | 402 mW |

- (1) This is the inverse of the junction-to-ambient thermal resistance when board-mounted (low-k) and with no air flow.

RECOMMENDED OPERATING CONDITIONS

| | | MIN | NOM | MAX | UNIT |
|--------------------------------|---|----------------------|-----------------------|----------------------|------|
| V _{CC} | Supply voltage | 3 | 3.3 | 3.6 | V |
| V _{IH} | High-level input voltage | 2 | | | V |
| V _{IL} | Low-level input voltage | | | 0.8 | V |
| I _O | Output current | −8 | | 8 | mA |
| V _{ID} | Magnitude of differential input voltage | 0.1 | | 0.6 | V |
| V _{IC} , see Figure 4 | Common-mode input voltage | $\frac{ V_{ID} }{2}$ | 2.4 | $\frac{ V_{ID} }{2}$ | V |
| | | | V _{CC} − 0.8 | | |
| T _A | Operating free-air temperature | SN75' | 0 | 70 | °C |
| | | SN65' | −40 | 85 | °C |

ELECTRICAL CHARACTERISTICS

over recommended operating conditions (unless otherwise noted)

| PARAMETER | | TEST CONDITIONS | MIN | TYP ⁽¹⁾ | MAX | UNIT |
|---------------------|---|--------------------------|--|--------------------|-----|------|
| V _{IT+} | Positive-going differential input voltage threshold | See Figure 1 and Table 1 | | | 100 | mV |
| V _{IT-} | Negative-going differential input voltage threshold | | -100 | | | mV |
| V _{OH} | High-level output voltage | I _{OH} = -8 mA | 2.4 | 3 | | V |
| V _{OL} | Low-level output voltage | I _{OL} = 8 mA | | 0.2 | 0.4 | V |
| I _{CC} | Supply current | 'LVDx386 | Enabled, No load | 50 | 70 | mA |
| | | 'LVDx388A | | 22 | 40 | |
| | | 'LVDx390 | | 8 | 18 | |
| | | 'LVDx386 | Disabled | | 3 | |
| | | 'LVDx388A | | | 3 | |
| | | 'LVDx390 | | | 1.5 | |
| I _I | Input current (A or B inputs) | 'LVDS | V _I = 0 V | -13 | -20 | μA |
| | | | V _I = 2.4 V | -1.2 | -3 | |
| | | 'LVDT | V _I = 0 V, other input open | | -40 | |
| | | | V _I = 2.4 V, other input open | -2.4 | | |
| I _{ID} | Differential input current I _{IA} - I _{IB} | 'LVDS | V _{IA} = 0 V, V _{IB} = 0.1 V, V _{IA} = 2.4 V, V _{IB} = 2.3 V | | ±2 | μA |
| I _{ID} | Differential input current (I _{IA} - I _{IB}) | 'LVDT | V _{IA} = 0.2 V, V _{IB} = 0 V, V _{IA} = 2.4 V, V _{IB} = 2.2 V | 1.5 | 2.2 | mA |
| I _{I(OFF)} | Power-off input current (A or B inputs) | 'LVDS | V _{CC} = 0 V, V _I = 2.4 V | 12 | ±20 | μA |
| I _{I(OFF)} | Power-off input current (A or B inputs) | 'LVDT | V _{CC} = 0 V, V _I = 2.4 V | | ±40 | μA |
| I _{IH} | High-level input current (enables) | | V _{IH} = 2 V | | 10 | μA |
| I _{IL} | Low-level input current (enables) | | V _{IL} = 0.8 V | | 10 | μA |
| I _{OZ} | High-impedance output current | | V _O = 0 V | | ±1 | μA |
| | | | V _O = 3.6 V | | 10 | |
| C _{IN} | Input capacitance, A or B input to GND | | V _{ID} = 0.4 sin 2.5E09 t V | 5 | | pF |
| Z _(t) | Termination impedance | | V _{ID} = 0.4 sin 2.5E09 t V | 88 | 132 | Ω |

(1) All typical values are at 25°C and with a 3.3-V supply.

SWITCHING CHARACTERISTICS

over recommended operating conditions (unless otherwise noted)

| PARAMETER | | TEST CONDITIONS | MIN | TYP ⁽¹⁾ | MAX | UNIT |
|--------------|---|-----------------|-----|--------------------|------|------|
| t_{PLH} | Propagation delay time, low-to-high-level output | See Figure 2 | 1 | 2.6 | 4 | ns |
| t_{PHL} | Propagation delay time, high-to-low-level output | | 1 | 2.5 | 4 | ns |
| t_r | Output signal rise time | | 500 | 800 | 1200 | ps |
| t_f | Output signal fall time | | 500 | 800 | 1200 | ps |
| $t_{sk(p)}$ | Pulse skew ($ t_{PHL} - t_{PLH} $) | | | 150 | 600 | ps |
| $t_{sk(o)}$ | Output skew ⁽²⁾ | | | 100 | 400 | ps |
| $t_{sk(pp)}$ | Part-to-part skew ⁽³⁾ | | | | 1 | ns |
| t_{PZH} | Propagation delay time, high-impedance-to-high-level output | See Figure 3 | | 7 | 15 | ns |
| t_{PZL} | Propagation delay time, high-impedance-to-low-level output | | | 7 | 15 | ns |
| t_{PHZ} | Propagation delay time, high-level-to-high-impedance output | | | 7 | 15 | ns |
| t_{PLZ} | Propagation delay time, low-level-to-high-impedance output | | | 7 | 15 | ns |

- (1) All typical values are at 25°C and with a 3.3-V supply.
- (2) $t_{sk(o)}$ is the magnitude of the time difference between the t_{PLH} or t_{PHL} of all drivers of a single device with all of their inputs connected together.
- (3) $t_{sk(pp)}$ is the magnitude of the difference in propagation delay times between any specified terminals of any two devices characterized in this data sheet when both devices operate with the same supply voltage, at the same temperature, and have the same test circuits.

PARAMETER MEASUREMENT INFORMATION

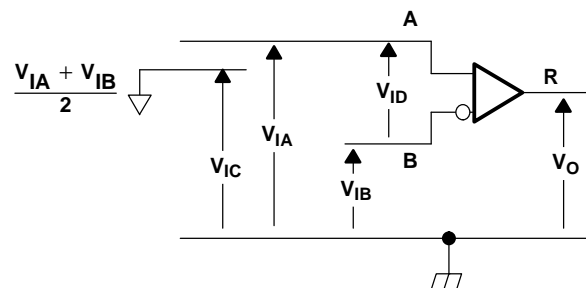
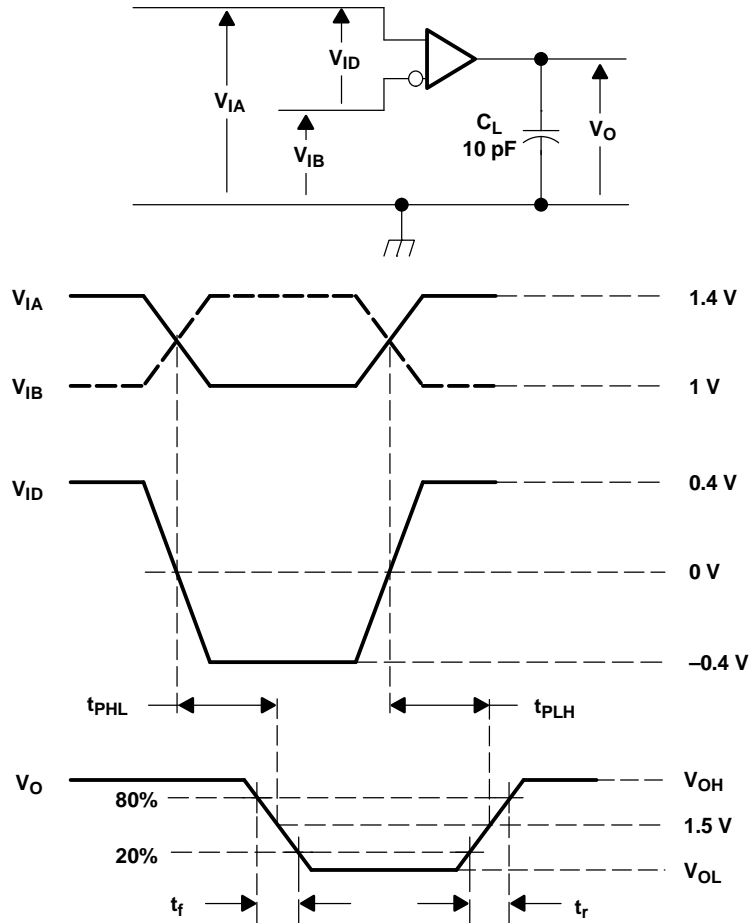


Figure 1. Voltage Definitions

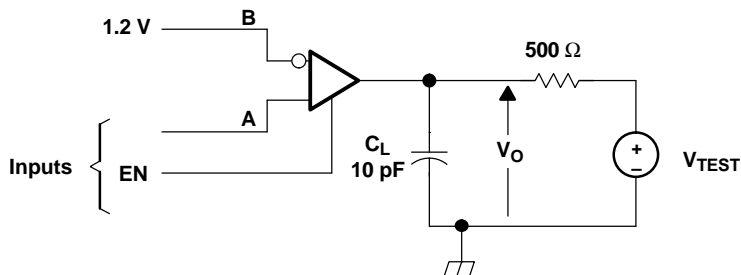
Table 1. Receiver Minimum and Maximum Input Threshold Test Voltages

| APPLIED VOLTAGES | | RESULTING DIFFERENTIAL INPUT VOLTAGE | RESULTING COMMON-MODE INPUT VOLTAGE |
|------------------|----------|--------------------------------------|-------------------------------------|
| V_{IA} | V_{IB} | V_{ID} | V_{IC} |
| 1.25 V | 1.15 V | 100 mV | 1.2 V |
| 1.15 V | 1.25 V | -100 mV | 1.2 V |
| 2.4 V | 2.3 V | 100 mV | 2.35 V |
| 2.3 V | 2.4 V | -100 mV | 2.35 V |
| 0.1 V | 0 V | 100 mV | 0.05 V |
| 0 V | 0.1 V | -100 mV | 0.05 V |
| 1.5 V | 0.9 V | 600 mV | 1.2 V |
| 0.9 V | 1.5 V | -600 mV | 1.2 V |
| 2.4 V | 1.8 V | 600 mV | 2.1 V |
| 1.8 V | 2.4 V | -600 mV | 2.1 V |
| 0.6 V | 0 V | 600 mV | 0.3 V |
| 0 V | 0.6 V | -600 mV | 0.3 V |



- A. All input pulses are supplied by a generator having the following characteristics: t_r or $t_f \leq 1 \text{ ns}$, pulse repetition rate (PRR) = 50 Mpps, pulse width = $10 \pm 0.2 \text{ ns}$. C_L includes instrumentation and fixture capacitance within 0,06 mm of the D.U.T.

Figure 2. Timing Test Circuit and Wave Forms



- A. All input pulses are supplied by a generator having the following characteristics: t_r or $t_f \leq 1$ ns, pulse repetition rate (PRR) = 0.5 Mpps, pulse width = 500 ± 10 ns. C_L includes instrumentation and fixture capacitance within 0,06 mm of the D.U.T.

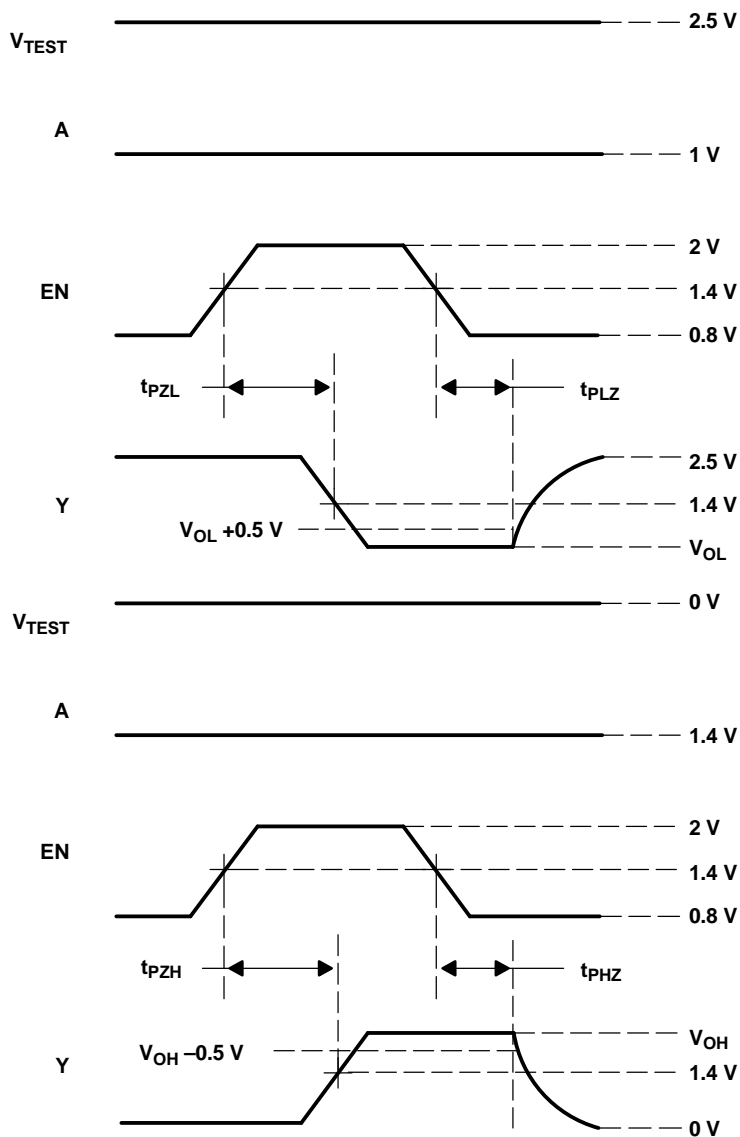


Figure 3. Enable/Disable Time Test Circuit and Wave Forms

TYPICAL CHARACTERISTICS

COMMON-MODE INPUT VOLTAGE
vs
DIFFERENTIAL INPUT VOLTAGE

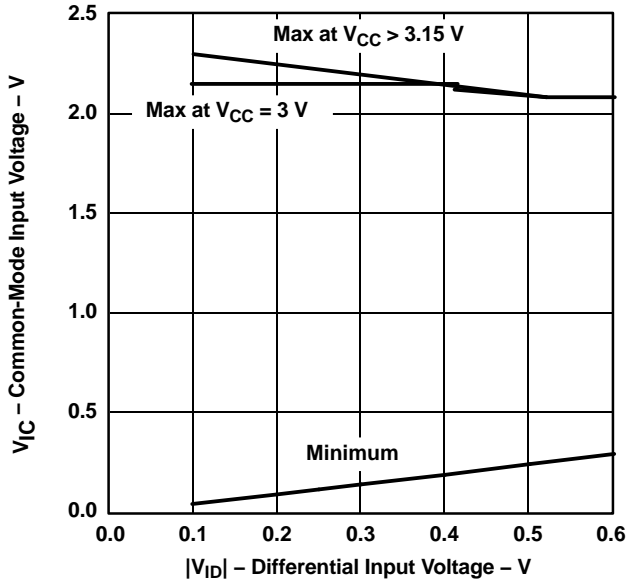


Figure 4.

LVDx390
SUPPLY CURRENT
vs
SWITCHING FREQUENCY

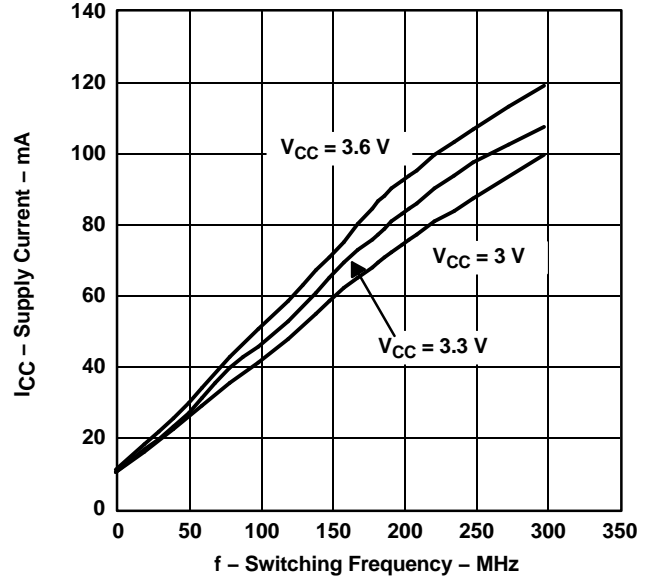


Figure 5.

LVDx388A
SUPPLY CURRENT
vs
SWITCHING FREQUENCY

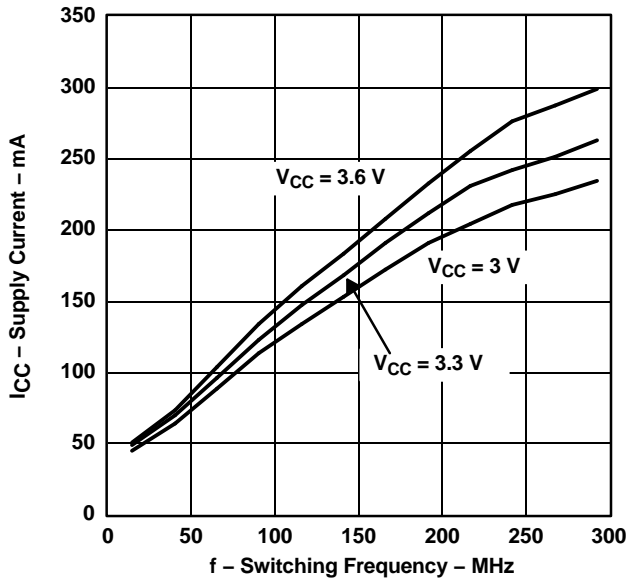


Figure 6.

LVDx386
SUPPLY CURRENT
vs
SWITCHING FREQUENCY

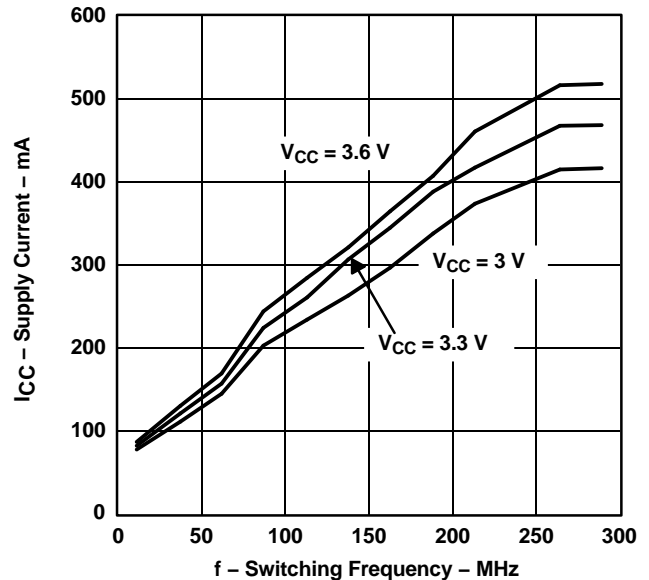


Figure 7.

TYPICAL CHARACTERISTICS (continued)

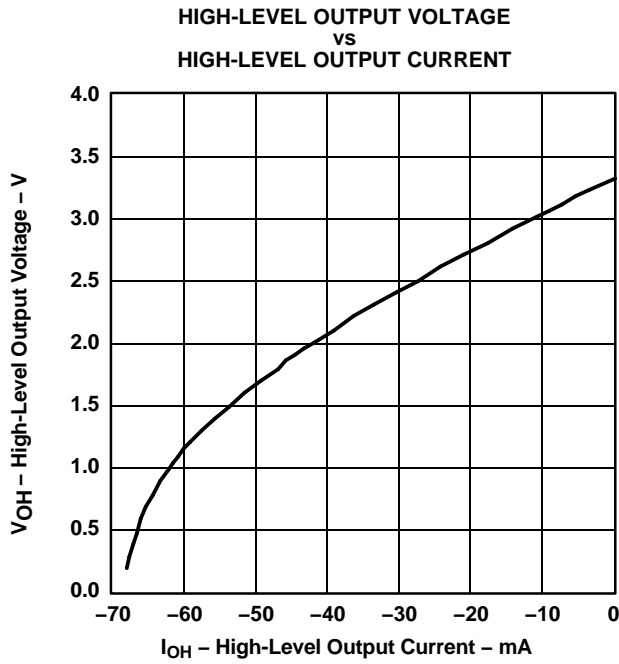


Figure 8.

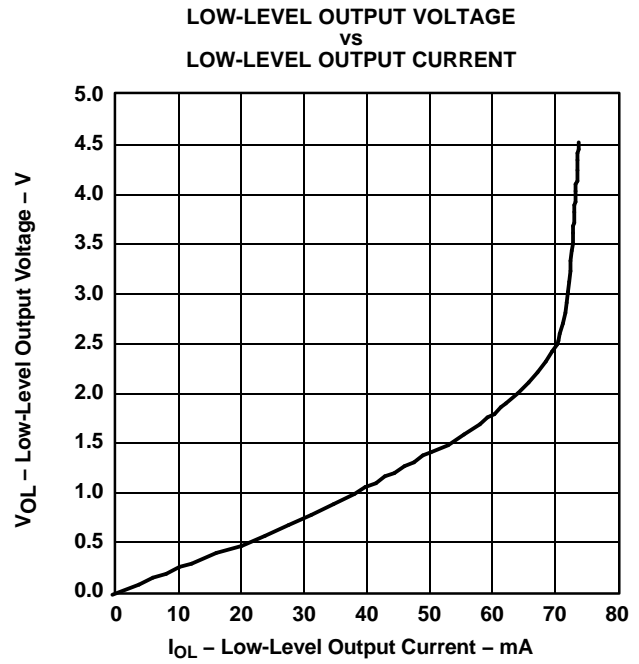


Figure 9.

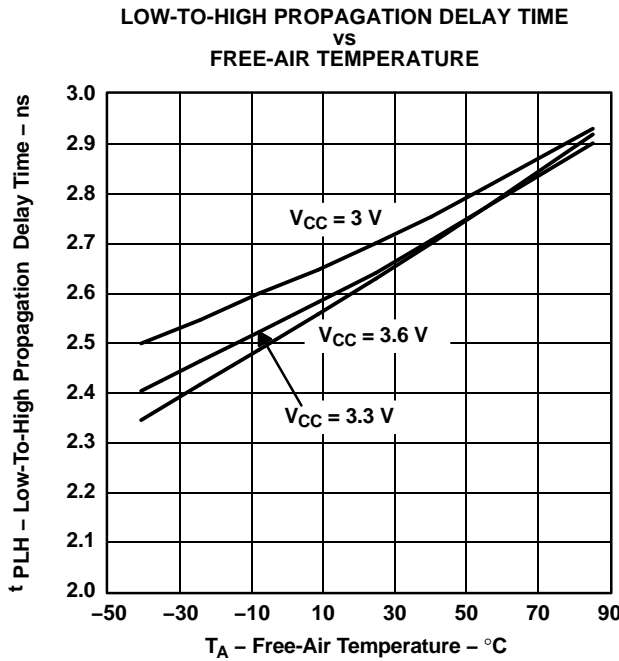


Figure 10.

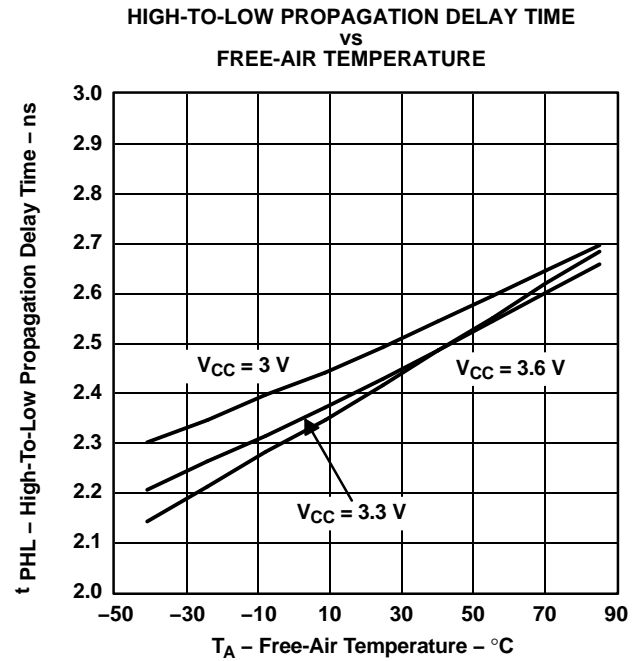


Figure 11.

APPLICATION INFORMATION

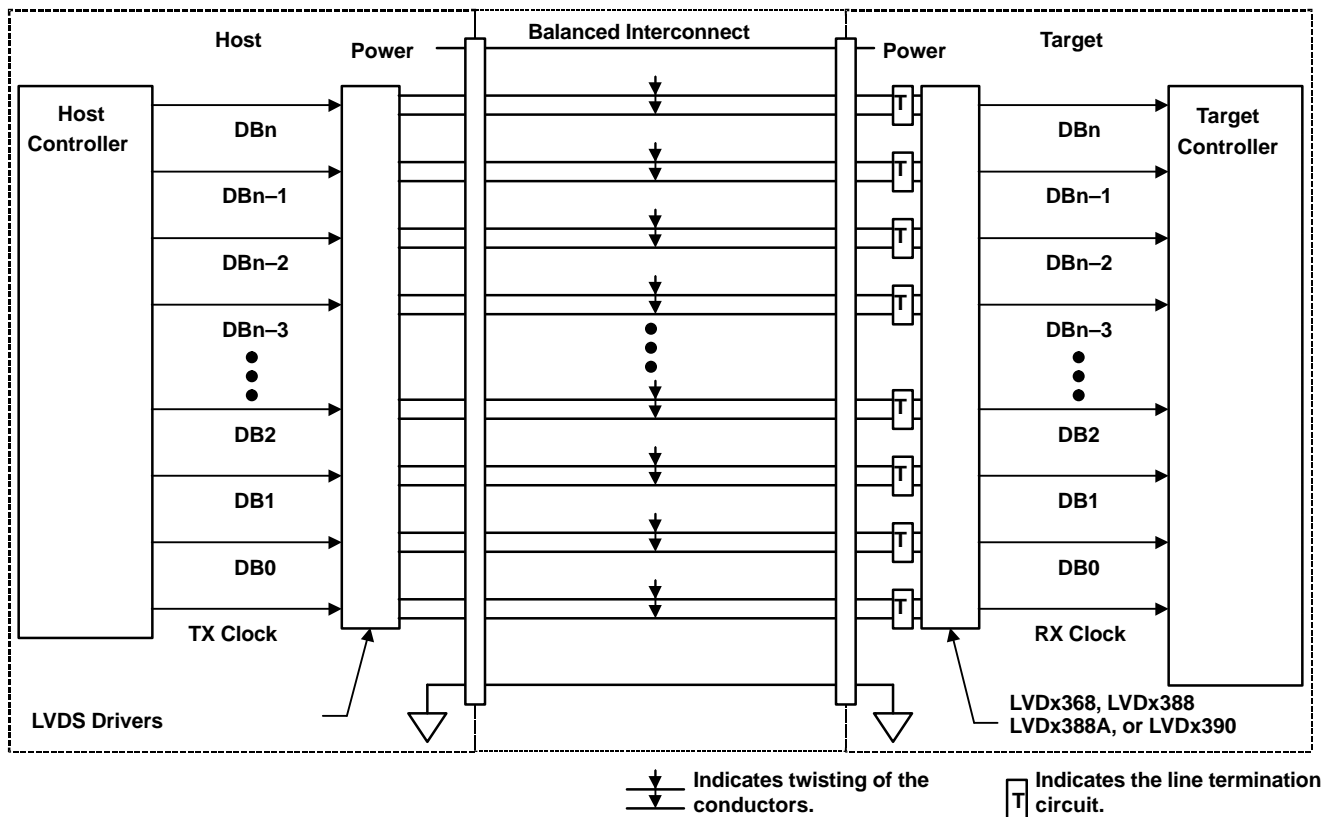


Figure 12. Typical Application Schematic

ANALOG AND DIGITAL GROUNDS/POWER SUPPLIES

Although it is not necessary to separate out the analog/digital supplies and grounds on the SN65LVDS/T388A and SN75LVDS/T388A, the pinout provides the user that option. To help minimize or perhaps eliminate switching noise being coupled between the two supplies, the user could lay out separate supply and ground planes for the designated pinout.

Most applications probably have all grounds connected together and all power supplies connected together. This configuration was used while characterizing and setting the data-sheet parameters.

FAIL SAFE

One of the most common problems with differential signaling applications is how the system responds when no differential voltage is present on the signal pair. The LVDS receiver is like most differential line receivers, in that its output logic state can be indeterminate when the differential input voltage is between -100 mV and 100 mV , and within its recommended input common-mode voltage range. TI's LVDS receiver is different in how it handles the open-input circuit situation, however.

Open-circuit means that there is little or no input current to the receiver from the data line itself. This could be when the driver is in a high-impedance state or the cable is disconnected. When this occurs, the LVDS receiver pulls each line of the signal pair to near V_{CC} through $300\text{-k}\Omega$ resistors, as shown in Figure 13. The fail-safe feature uses an AND gate with input voltage thresholds at about 2.3 V to detect this condition and force the output to a high-level, regardless of the differential input voltage.

APPLICATION INFORMATION (continued)

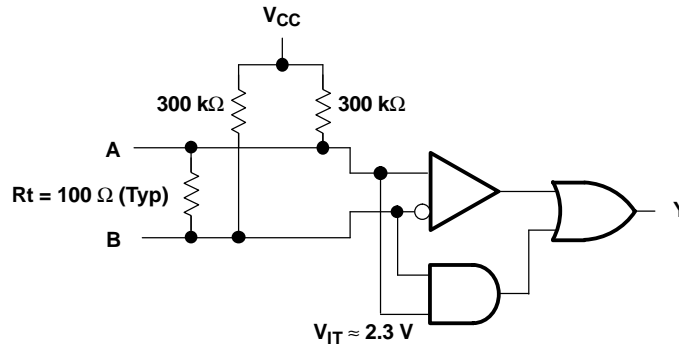


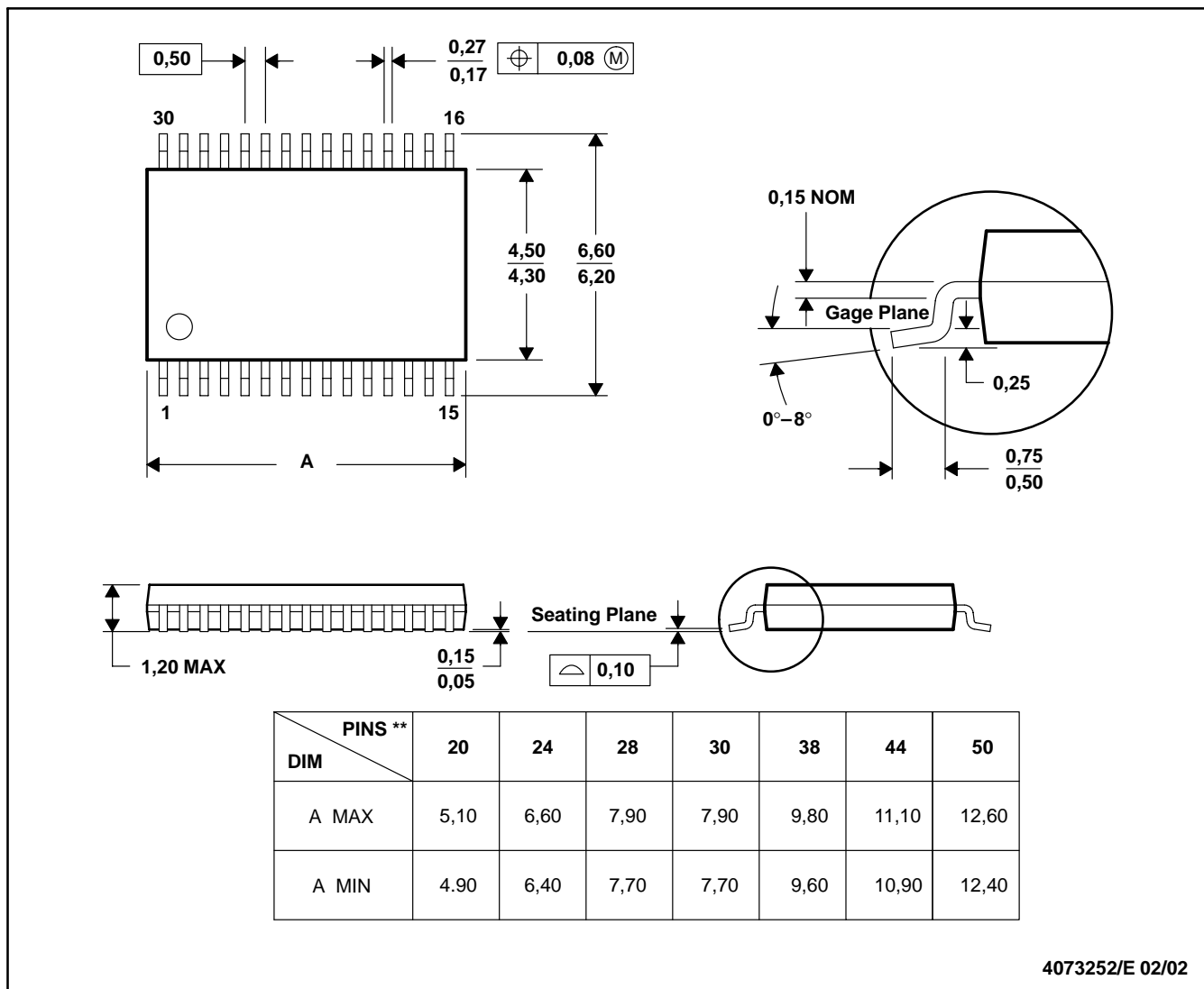
Figure 13. Open-Circuit Fail Safe of the LVDS Receiver

It is only under these conditions that the output of the receiver is valid with less than a 100-mV differential input voltage magnitude. The presence of the termination resistor, R_t , does not affect the fail-safe function as long as it is connected as shown in the figure. Other termination circuits may allow a dc current to ground that could defeat the pullup currents from the receiver and the fail-safe feature.

DBT (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

30 PINS SHOWN



4073252/E 02/02

- NOTES: A. All linear dimensions are in millimeters.
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold flash or protrusion.
 D. Falls within JEDEC MO-153

PW (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

14 PINS SHOWN



4040064/F 01/97

- NOTES: A. All linear dimensions are in millimeters.
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
 D. Falls within JEDEC MO-153

DGG (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

48 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold protrusion not to exceed 0,15.
 D. Falls within JEDEC MO-153

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